

10A, 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

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- Low voltage, high frequency, inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.196g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
l _F	10	Α			
V_{RRM}	200	V			
I _{FSM}	120	Α			
T _{J MAX}	150	°C			
Package	ThinDPAK				
Configuration	Common cathode				



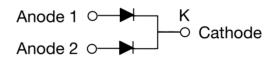








ThinDPAK



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	MBRAD10200DH	UNIT		
Marking code on the device		10200D			
Repetitive peak reverse voltage	V _{RRM}	200	V		
Reverse voltage, total rms value	$V_{R(RMS)}$	140	V		
Forward current per device	lF	10	А		
Surge peak forward current single half sine wave t = 8.3m			120	А	
superimposed on rated load per diode	t = 1.0ms	I _{FSM}	240	Α	
Junction temperature	TJ	-55 to +150	°C		
Storage temperature	T _{STG}	-55 to +150	°C		



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance ⁽¹⁾	R _{OJL}	1.8	°C/W		
Junction-to-ambient thermal resistance ⁽²⁾	RөJA	12.1	°C/W		
Junction-to-case thermal resistance ⁽²⁾	Rejc	3.7	°C/W		

Notes:

- 1. With ideal heat sink
- 2. Units mounted on 2" x 3" x 0.25" Al-plate

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
	I _F = 2.5A, T _J = 25°C		0.77	-	V
	I _F = 5.0A, T _J = 25°C	V _F	0.83	0.88	V
Forward voltage per diode ⁽¹⁾	I _F = 2.5A, T _J = 125°C		0.63	-	V
	I _F = 5.0A, T _J = 125°C		0.70	0.74	V
Poverse current @ reted //_ per diade(2)	T _J = 25°C	I_	-	10	μA
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C	l _R	-	1	mA
Junction capacitance per diode	1MHz, V _R = 4.0V	СJ	78	-	pF

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE	PACKAGE	PACKING			
MBRAD10200DH	ThinDPAK	4,500 / Tape & Reel			



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

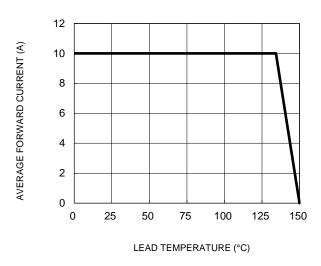


Fig.3 Typical Reverse Characteristics

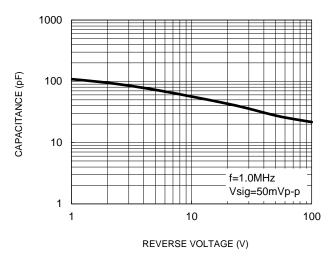


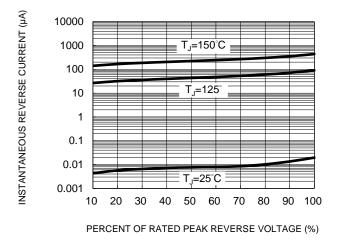
Fig.2 Typical Junction Capacitance

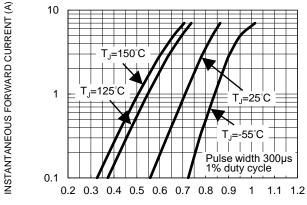
Fig.4 Typical Forward Characteristics

FORWARD VOLTAGE (V)

T₁=25°C

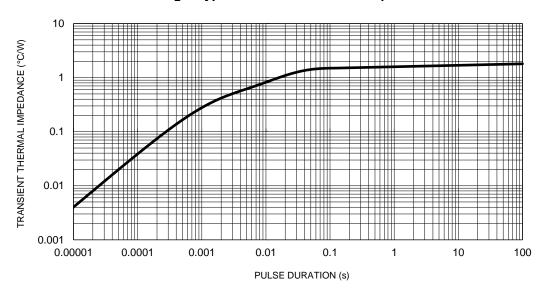
Pulse width 300µs 1% duty cycle





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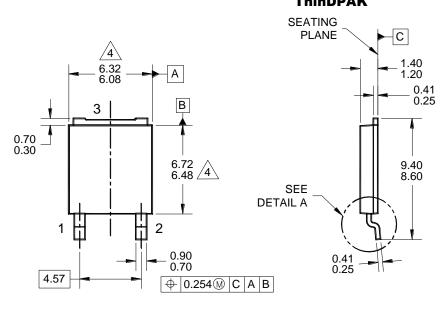
Fig.5 Typical Transient Thermal Impedance

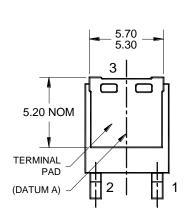


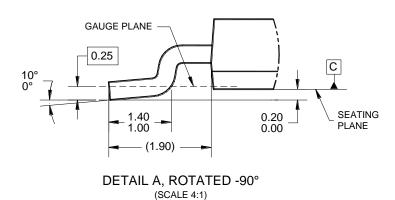


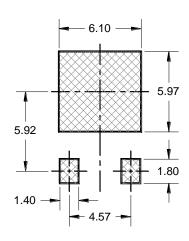
PACKAGE OUTLINE DIMENSIONS

ThinDPAK

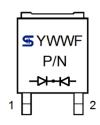








SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW = DATE CODE F = FACTORY CODE P/N = MARKING CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
 - 5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.



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